

Technical Data Sheet

BERGQUIST HI FLOW THF 800AC

Known as BERGQUIST HI-FLOW 115-AC April 2020

PRODUCT DESCRIPTION

Phase Change Coated Aluminum.

Technology	Phase Change
Appearance	Gray
Reinforcement Carrier	Fiberglass
Total Thickness	0.139 mm
, ASTM D374	
Application	Thermal management,
	Thermally conductive adhesive
Operating Temperature	150 °C

FEATURES AND BENEFITS

- Thermal impedance: 0.37°C-in²/W @ 25 psi
- Can be applied directly to a cold heat sink
- One side adhesive-coated to aid in positioning
- Fiberglass reinforced

TYPICAL APPLICATIONS

- Computer and peripherals
- As a thermal interface where bare die is exposed and needs to be heat sinked

BERGQUIST HI FLOW THF 800AC is a thermally conductive fiber reinforced phase change material. The product consists of a thermally conductive 65°C phase change compound coated on fiberglass web, and an adhesive coating on one side for attachment to a cold heat sink. There is no need to preheat the heat sink to apply the BERGQUIST HI FLOW THF 800AC.

BERGQUIST HI FLOW THF 800AC is designed as a thermal interface material between a computer processor and a heat sink. The pressure sensitive adhesive makes it simple to apply in high volume to heat sinks and the 65°C phase change temperature eliminates shipping and handling problems.

BERGQUIST HI FLOW THF 800AC requires no protective liner for shipping or handling. The HI-FLOW coating has excellent handling characteristics at room temperature, and can withstand the handling and shipping process without protection

BERGQUIST HI FLOW THF 800AC handles like a Sil Pad at room temperature and flows like high-quality grease at elevated temperatures.

TYPICAL PROPERTIES

Physical Properties

Physical Properties		65
Phase Change Temperature, ASTM D3418, °C Elongation , 45° to warp and fill, ASTM D882A,% Flammability Rating, UL 94		
Tensile Strength, ASTM D882A	MPa (psi)	6 (900)
Electrical Properties		
Dielectric Breakdown Voltage, ASTM D149, VAC Dielectric Constant , ASTM D150 @ 1,000 Hz Volume Resistivity, ASTM D257, ohm-meter		
Thermal Properties	$l(\mathbf{m}, \mathbf{k})$ (1)	0.9
Thermal Conductivity , ASTM D5470, W/	(m- k) ()	0.8
Thermal Performance vs. Pressure TO-220 Thermal Performance, °C/W		
@ 10 psi		1.28
@ 25 psi		
@ 50 psi		
@ 100 psi		0.94
@ 200 psi		0.85
Thermal Impedance, ASTM D5470, °C-i	n²/W (2)	
@ 10 psi		0.44
@ 25 psi		0.37
@ 50 psi		0.35
@ 100 psi		0.27
@ 200 psi		0.15

1) This is the measured thermal conductivity of the Hi-Flow coating. It represents one conducting layer in a three-layer laminate. The Hi-Flow coatings are phase change compounds. These layers will respond to heat and pressure induced stresses. The overall conductivity of the material in post-phase change, thin film products is highly dependent upon the heat and pressure applied. This characteristic is not accounted for in ASTM D5470. Please contact Bergquist Product Management if additional specifications are required.

2) The ASTM D5470 test fixture was used and the test sample was conditioned at 70°C prior to test. The recorded value includes interfacial thermal resistance. These values are provided for reference only. Actual application performance is directly related to the surface roughness, flatness and pressure applied.

GENERAL INFORMATION

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.



CONFIGURATIONS AVAILABLE

BERGQUIST HI FLOW THF 800AC is supplied in:

- Sheet form, roll form and die-cut parts
- With pressure-sensitive adhesive

Conversions

 $(^{\circ}C \ge 1.8) + 32 = ^{\circ}F$ kV/mm x 25.4 = V/mil mm / 25.4 = inches N x 0.225 = lb/F N/mm x 5.71 = lb/in psi x 145 = N/mm² MPa = N/mm² N·m x 8.851 = lb·in N·m x 0.738 = lb·ft N·mm x 0.142 = oz·in mPa·s = cP

Disclaimer

Note:

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product. Any liability in respect of the information in the Technical Data Sheet or any other written or oral recommendation(s) regarding the concerned product is excluded, except if otherwise explicitly agreed and except in relation to death or personal injury caused by our negligence and any liability under any applicable mandatory product liability law.

In case products are delivered by Henkel Belgium NV, Henkel Electronic Materials NV, Henkel Nederland BV, Henkel Technologies France SAS and Henkel France SA please additionally note the following:

In case Henkel would be nevertheless held liable, on whatever legal ground, Henkel's liability will in no event exceed the amount of the concerned delivery.

In case products are delivered by Henkel Colombiana, S.A.S. the following disclaimer is applicable:

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

Any liability in respect of the information in the Technical Data Sheet or any other written or oral recommendation(s) regarding the concerned product is excluded, except if otherwise explicitly agreed and except in relation to death or personal injury caused by our negligence and any liability under any applicable mandatory product liability law.

In case products are delivered by Henkel Corporation, Resin Technology Group, Inc., or Henkel Canada Corporation, the following disclaimer is applicable:

The data contained herein are furnished for information only and are believed to be reliable. We cannot assume responsibility for the results obtained by others over whose methods we have no control. It is the user's responsibility to determine suitability for the user's purpose of any production methods mentioned herein and to adopt such precautions as may be advisable for the protection of property and of persons against any hazards that may be involved in the handling and use thereof. In light of the foregoing, Henkel Corporation specifically disclaims all warranties expressed or implied, including warranties of merchantability or fitness for a particular purpose, arising from sale or use of Henkel Corporation's products. Henkel Corporation specifically disclaims any liability for consequential or incidental damages of any kind, including lost profits. The discussion herein of various processes or compositions is not to be interpreted as representation that they are free from domination of patents owned by others or as a license under any Henkel Corporation patents that may cover such processes or compositions. We recommend that each prospective user test his proposed application before repetitive use, using this data as a guide. This product may be covered by one or more United States or foreign patents or patent applications.

Trademark usage

Except as otherwise noted, all trademarks in this document are trademarks of Henkel Corporation in the U.S. and elsewhere. ® denotes a trademark registered in the U.S. Patent and Trademark Office.

Reference 2